

**Harvatek Surface Mount CHIP LED Data Sheet
HT-T368FCH-XXXX**

Official Product	HT Part No. HT-T368FCH-XXXX	Customer Part No.	Data Sheet No.
Tentative Product	*****	*****	HT-T368FCH-XXXX
Specifications are subject to change without notice. Data and drawings herein are copyrighted.	Jan. 3, 2007	Version of 1.0	Page 1/16

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DISCLAIMER

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LIFE SUPPORT POLICY

HARVATEK's products are not authorized for use as critical components in life support devices or systems without the express written approval of the President of HARVATEK or HARVATEK INTERNATIONAL. As used herein:

1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, and (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury of the user.
2. A critical component in any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

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Product Specifications

	Specification	Material	Quantity
IV	Red : 90.0 – 227.0mcd Green : 560.0 – 800.0mcd Blue : 45.0 – 112.5mcd @20mA/ Ta= 25° C		
λ _D	Red : 615 - 635nm Green : 515 - 535nm Blue : 465 – 475nm @20mA/ Ta= 25° C		
V _f	Red : 2.4 V maximum Green : 3.9 V maximum Blue : 3.9 V maximum @20mA/ Ta= 25° C		
I _r	< 100 μA @ V _R = 5 V		
Resin	Water clear	Epoxy resin	
Carrier tape	EIA 481-1A specs	Conductive black tape	2000pcs per reel
Reel	EIA 481-1A specs	Conductive black	
Label	HT standard	Paper	
Packing bag	220x240mm	Aluminum laminated bag/ no-zipper	One reel per bag
Carton	HT standard	Paper	Non-specified

Others:

Each immediate box consists of 5 reels. The 5 reels may not necessarily have the same lot number or the same bin combinations of IV, λ_D and V_f. Each reel has a label identifying its specification; the immediate box consists of a product label as well.

ATTENTION: Electrostatic Discharge (ESD) protection

The symbol to the left denotes that ESD precaution is needed. ESD protection for GaP and AlGaAs based chips is necessary even though they are relatively safe in the presence of low static-electric discharge. Parts built with AlInGaP, GaN, or/and InGaN based chips are **STATIC SENSITIVE devices**. ESD precaution must be taken during design and assembly.

If manual work or processing is needed, please ensure the device is adequately protected from ESD during the process.

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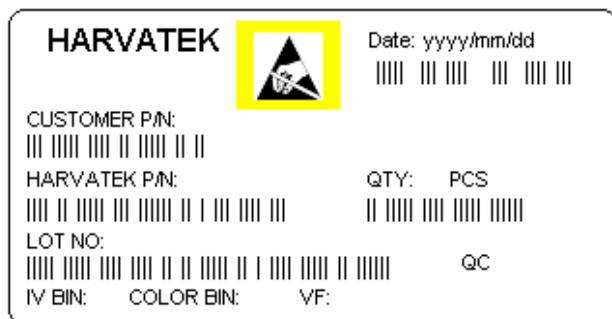
Compliance and Certification

ISO9002, QS9000 and ISO14001 Certified

RoHS Compliant



Label Specifications



■ Customer P/N: To Be Defined

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Harvatek P/N:

H T - T 3 6 8 FCH - X X X X

Series Name	Emitting Color	Customer Code
HT-T368 HT: Harvatek T: tLED® series 3.5(L) x 2.7(W) x 1.8(H) mm 3: 3-dice configuration 68: PLCC4 package	FCH RGB @ 20mA per die	XXXX Customer Product Code TBD

Lot No.:

1 2 3 4 5 6 7 8 9 10

P 1 2 2 3 0 A - D T

Code 1	Code 2	Code 3	Code 4, 5	Code 6, 7	Code 9	Code 10
	Mfg. Year	Mfg. Month	Mfg. Date	Lots	Resin Color	Packaging
Internal Tracing Code	Z: 2000 1: 2001 2: 2002 3: 2003	1: Jan. 2: Feb. 9: Sep. A: Oct. B: Nov. C: Dec.	1~31/ (30)	01~99, A,B,C...	C: Clear D: Milky White	T: Tape & Reel

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■ Luminous Intensity (I_v) Bin:

Color	Bin Code	Spec. Range
Red	Q2	90.0-112.5 mcd
	R	112.5-180.0mcd
	S1	180.0-227.0mcd
Green	W	560.0-715.0 mcd
	X1	715.0-800.0mcd
Blue	P	45.0-71.5mcd
	Q	71.5-112.5mcd

■ Dominant Wavelength (λ_D) Bin:

Color	Bin Code	Spec. Range
Red	A	615.0-620.0 nm
	B	620.0-625.0 nm
	C	625.0-630.0 nm
	D	630.0-635.0 nm
Green	A	515.0-520.0 nm
	B	520.0-525.0 nm
	C	525.0-530.0 nm
	D	530.0-535.0 nm
Blue	B	465.0-470.0 nm
	C	470.0-475.0 nm

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Forward Voltage (Vf) Bin:

Color	Bin Code	Spec. Range
Blue (NB) Green (NG)	G8	2.7-2.9 V
	H7	2.9-3.1 V
	H8	3.1-3.3 V
	J7	3.3-3.5 V
	J8	3.5-3.7 V
	K7	3.7-3.9 V
Red (USD)	-	1.6-2.4 V

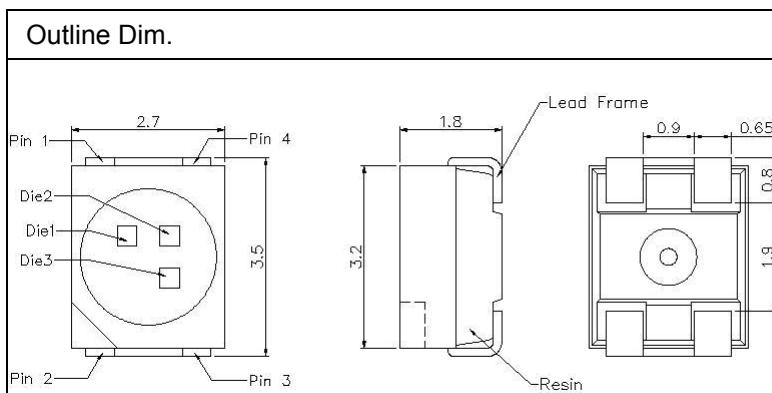
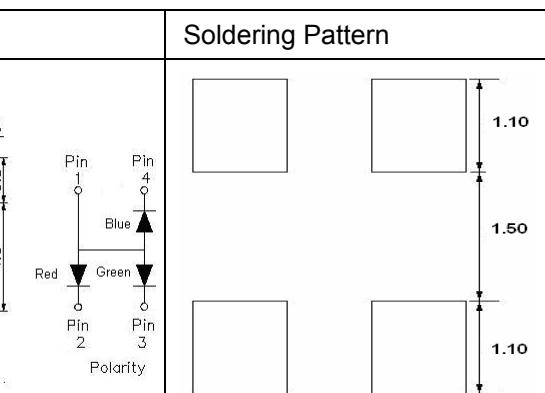
Product Features**Electro-Optical Characteristics**(I_F @ 20mA, T_a = 25 °C)

Code for parts	Lighting Color		V _F (V)		λ(nm)			I _V (mcd)	Typical
			typ	max	λ _D	λ _P	△λ		
HT-T368FCH	Ultra Bright Red	USD	1.9	2.4	624	630	17	150	
	Green	NG	2.7	3.9	525	520	40	700	
	Blue	NB	2.7	3.9	470	468	26	80	

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Package Outline Dimension and Recommended Soldering Pattern for Reflow Soldering

Unit: mm Tolerance: +/-0.1

Outline Dim.	Soldering Pattern
	

Soldering terminals may shift in the x, y direction.

Absolute Maximum Ratings

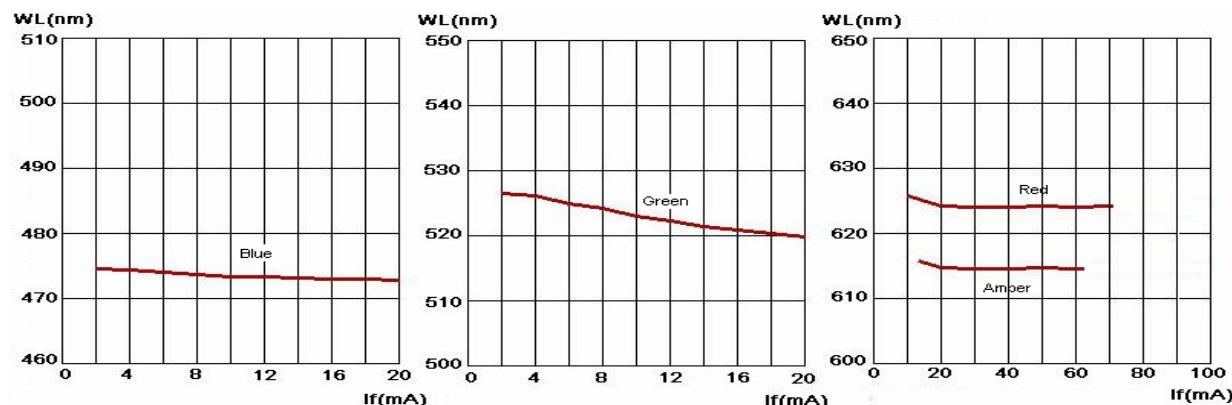
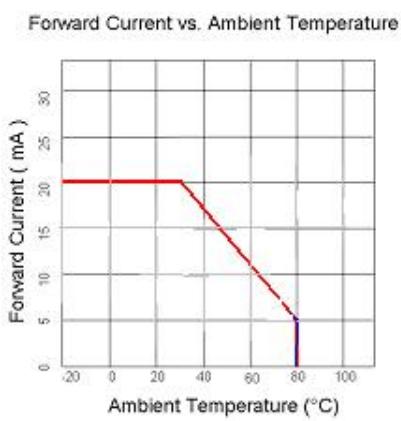
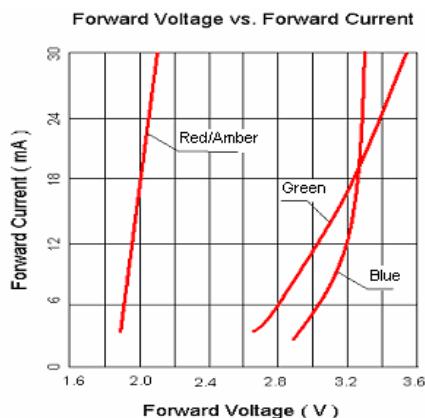
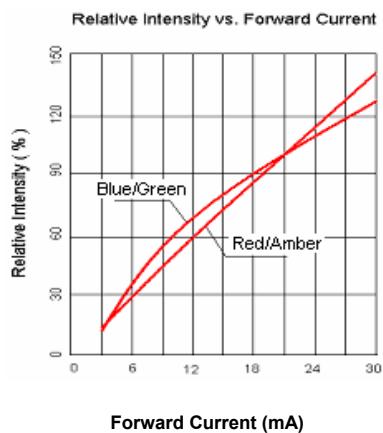
(Ta 25 °C)

Series	P _d (mW)	I _F (mA)	I _{FP} (mA)	V _R (V)	I _R (uA)	T _{OP} (°C)	T _{ST} (°C)
Red	46	20	100	5	<100@ V _R = 5	-30~+80	-40~+85
Blue/Green	74	20	80				

** Condition for I_{FP} is pulse of 1/10 duty and 0.1msec width

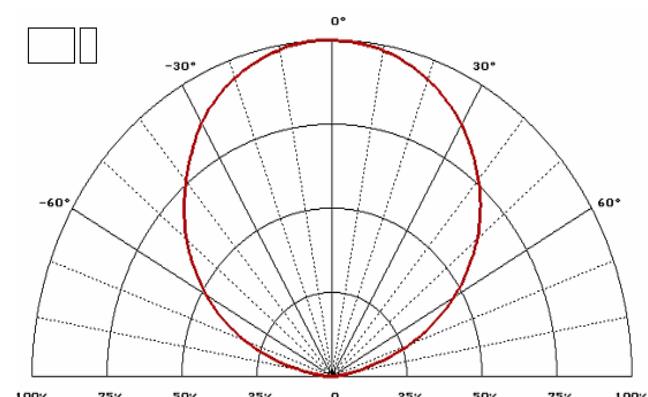
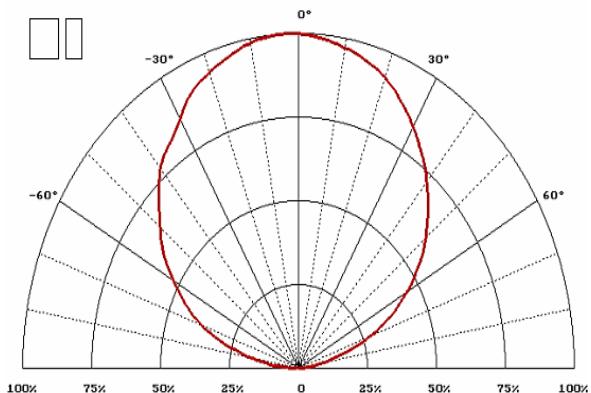
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Characteristics Curves

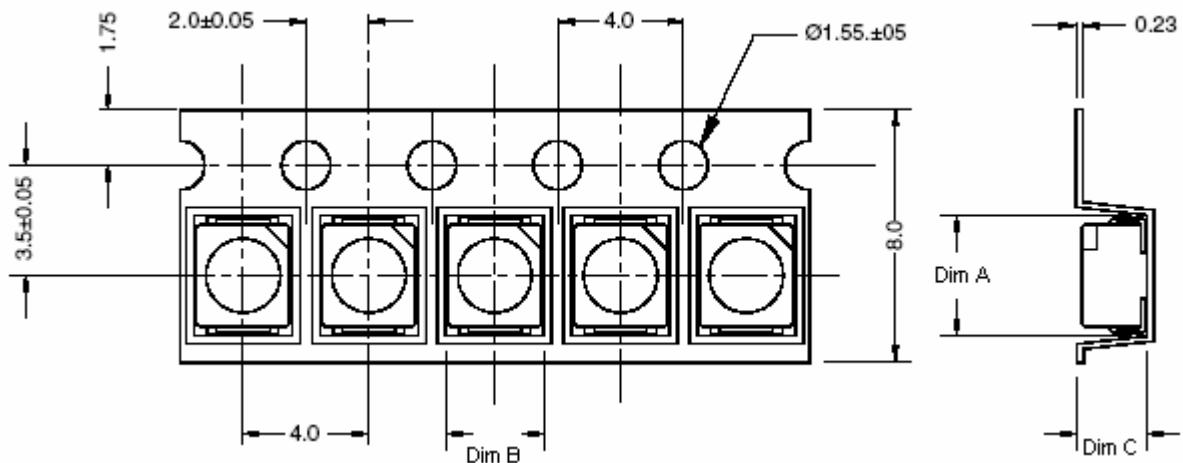


Wavelength vs. Forward Current

Directive Characteristics

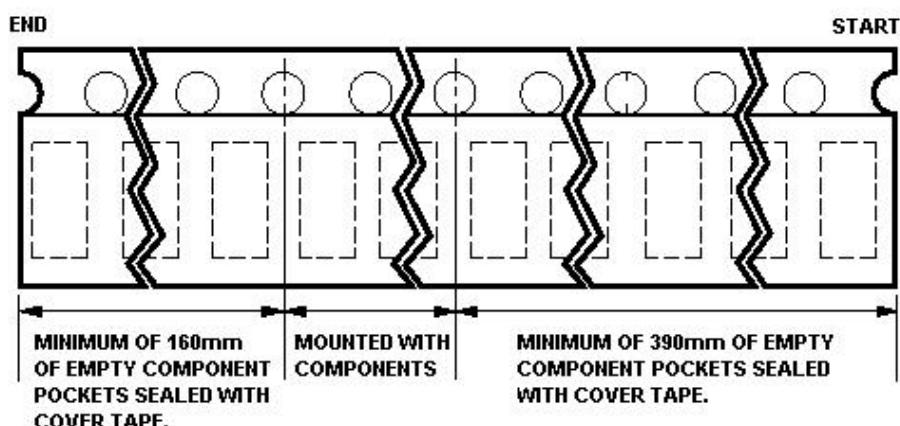


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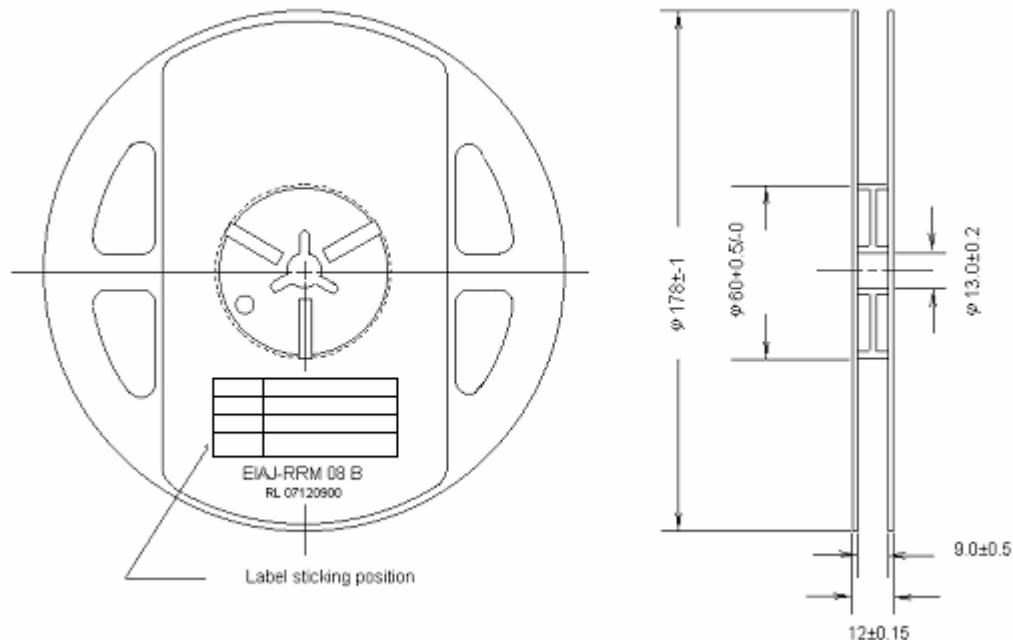
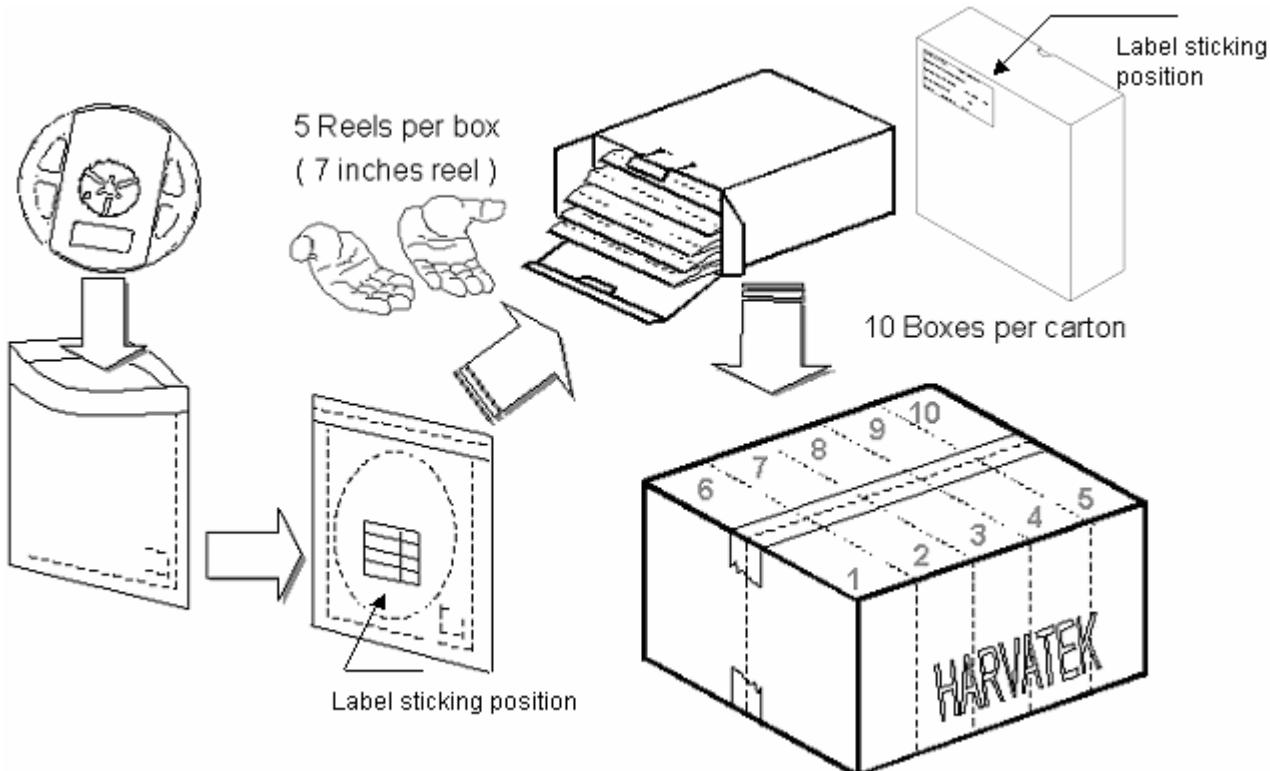
Packaging**Tape Dimension**

Part No.	Dim. A	Dim. B	Dim. C	Q'ty/Reel
HT-TX68	3.73±0.10	2.95±0.10	2.12±0.05	2K

Unit: mm



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Reel Dimension**Packing**

5 boxes per carton is available depending on shipment quantity.

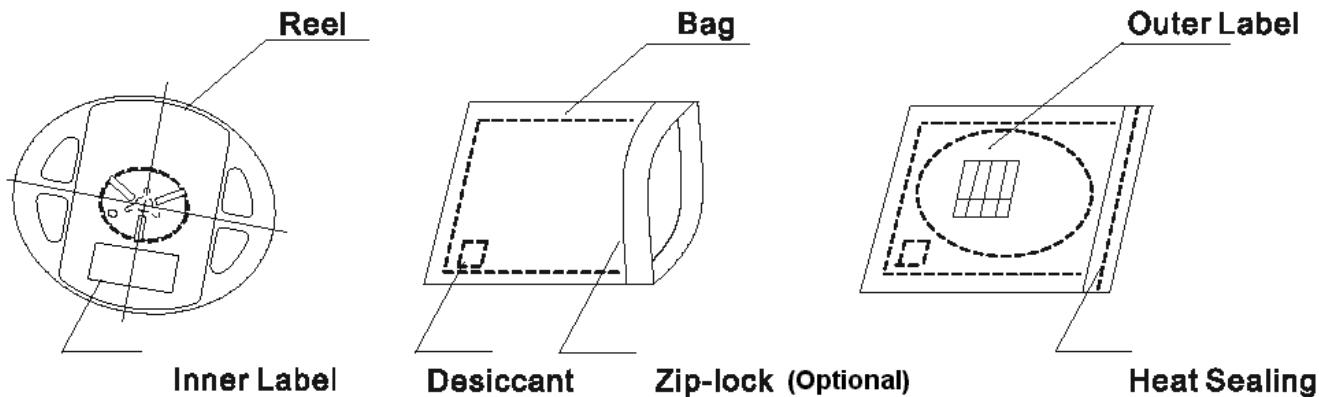
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Dry Pack

All SMD optical devices are **MOISTURE SENSITIVE**. Avoid exposure to moisture at all times during transportation or storage. Every reel is packaged in a moisture protected anti-static bag. Each bag is properly sealed prior to shipment.

Upon request, a humidity indicator will be included in the moisture protected anti-static bag prior to shipment.

The packaging sequence is as follows:



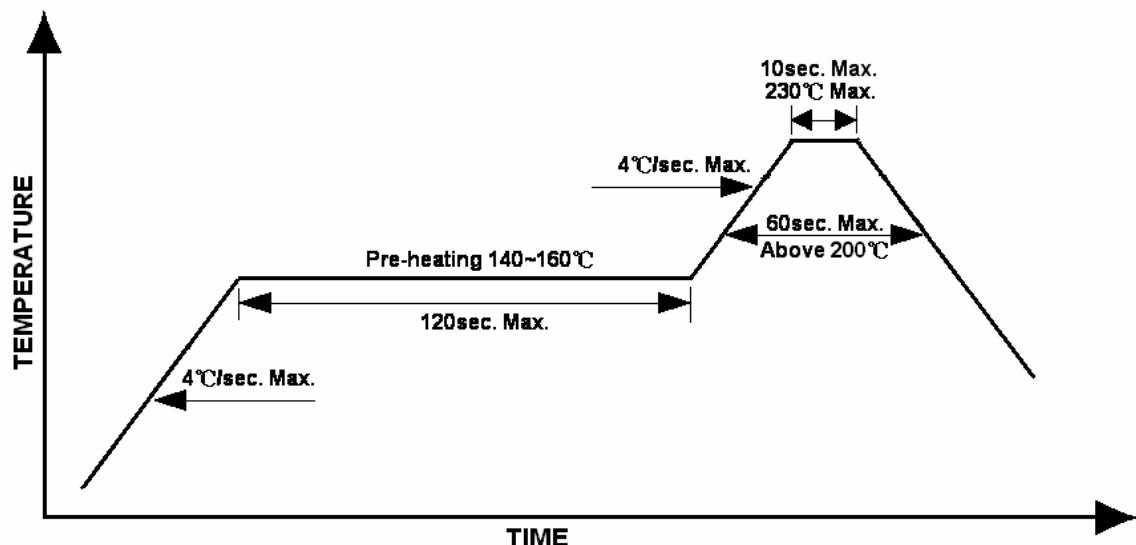
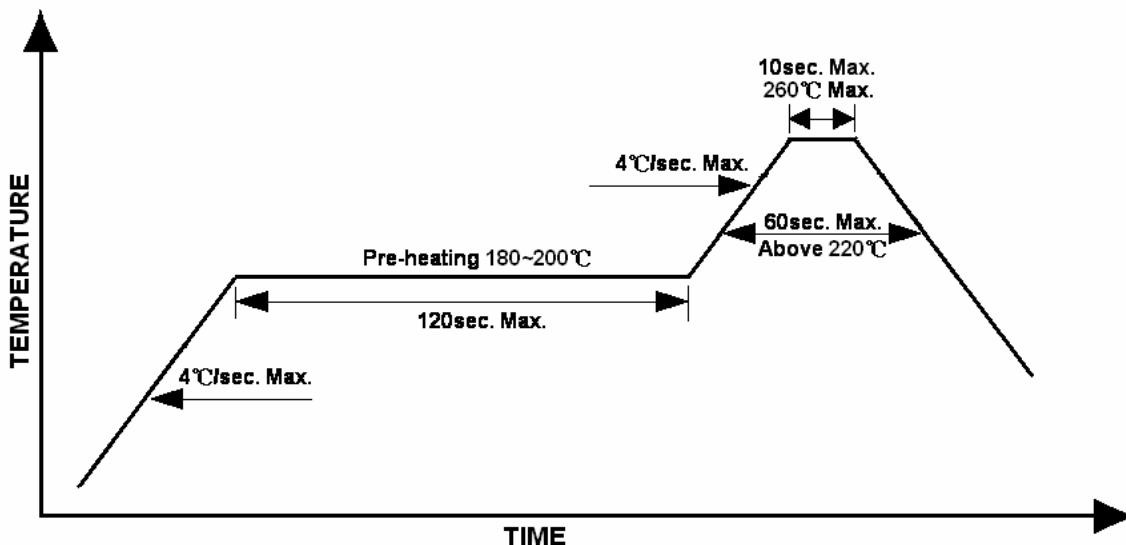
PRECAUTIONS

1. Avoid exposure to moisture at all times during transportation or storage.
2. Anti-Static precaution must be taken when handling GaN, InGaN, and AlInGaN products.
3. It is suggested to connect the unit with a current limiting resistor of the proper size. Avoid applying a reverse voltage beyond the specified limit.
4. Avoid operation beyond the limits as specified by the absolute maximum ratings.
5. Avoid direct contact with the surface through which the LED emits light.
6. If possible, assemble the unit in a clean room or dust-free environment.

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Reflow Soldering

- Recommended tin glue specifications: melting temperature in the range of 178~192 °C
- The recommended reflow soldering profile is as follows (temperatures indicated are as measured on the surface of the LED resin):

Lead Solder Profile**Lead-free Solder Profile**

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Reworking

- Rework should be completed within 5 seconds under 260 °C.
- The iron tip must not come in contact with the copper foil.
- Twin-head type is preferred.

Cleaning

Following are cleaning procedures after soldering:

- An alcohol-based solvent such as isopropyl alcohol (IPA) is recommended.
- Temperature x Time should be 50°C x 30sec. or <30°C x 3min
- Ultra sonic cleaning: < 15W/ bath; bath volume ≤ 1liter
- Curing: 100 °C max, <3min

Cautions of Pick and Place

- Avoid stress on the resin at elevated temperature.
- Avoid rubbing or scraping the resin by any object.
- Electric-static may cause damage to the component. Please ensure that the equipment is properly grounded. Use of an ionizer fan is recommended.

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Revision History

Changes since last revision	Page	Version No.	Revision Date
New format		1.0	01-03-2007

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